

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6664457

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KUO-CHUN LEE	03/25/2021
ARVIND VARDARAJAN SANTHANAM	03/24/2021
BRIAN CLARKE BANISTER	03/24/2021
RAGHU NARAYAN CHALLA	03/25/2021
RUHUA HE	03/25/2021
DANIEL AMERGA	10/22/2020
SUBASHINI KRISHNAMURTHY	03/29/2021
SCOTT HOOVER	03/25/2021
SANDEEP RAO	03/28/2021
ZHANG ZHOU	03/24/2021
RECEIVING PARTY DATA	
Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714
PROPERTY NUMBERS Total: 2	
Property Type	Number
Application Number:	16986135
Application Number:	62883565
CORRESPONDENCE DATA	
Fax Number:	(202)857-6395
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	213-629-7400
Email:	rachele.wittwer@arentfox.com, patentdocket@arentfox.com
Correspondent Name:	ARENT FOX AND QUALCOMM INCORPORATED
Address Line 1:	1717 K STREET, NW
Address Line 4:	WASHINGTON, D.C. 20006-5344

ATTORNEY DOCKET NUMBER:	030284.18715/194111
NAME OF SUBMITTER:	RACHELE WITTWER
SIGNATURE:	/Rachele Wittwer/
DATE SIGNED:	04/19/2021

Total Attachments: 12

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ASSIGNMENT

WHEREAS, WE,

1. **Kuo-Chun LEE**, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
2. **Arvind Vardarajan SANTHANAM**, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
3. **Brian Clarke BANISTER**, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
4. **Raghu Narayan CHALLA**, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
5. **Ruhua HE**, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
6. **Daniel AMERGA**, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
7. **Subashini KRISHNAMURTHY**, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
8. **Scott HOOVER**, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
9. **Sandeep RAO**, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
10. **Zhang ZHOU**, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **UPDATE MMW CODEBOOK FOR SMART PHONE COVER CHANGE** (collectively the “**INVENTIONS**”) for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter “**ASSIGNEE**”), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said **INVENTIONS**, including all inventions related thereto or thereof, all patent applications

therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 16/986,135 filed August 5, 2020, Qualcomm Reference No. 194111, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 62/883,565, filed August 6, 2019, Qualcomm Reference No. 194111P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;


AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect

for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at <u>San Diego, CA</u> , on <u>3/25/2021</u>	
City, State Date	Kuo-Chun LEE
Done at _____, on _____	
City, State Date	Arvind Vardarajan SANTHANAM
Done at _____, on _____	
City, State Date	Brian Clarke BANISTER
Done at _____, on _____	
City, State Date	Raghu Narayan CHALLA
Done at _____, on _____	
City, State Date	Ruhua HE
Done at _____, on _____	
City, State Date	Daniel AMERGA
Done at _____, on _____	
City, State Date	Subashini KRISHNAMURTHY
Done at _____, on _____	
City, State Date	Scott HOOVER
Done at _____, on _____	
City, State Date	Sandeep RAO
Done at _____, on _____	
City, State Date	Zhang ZHOU

for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____	_____
City, State Date	Kuo-Chup LEE
Done at SANDIEGO, USA, on 03/24/2021	<i>[Signature]</i>
City, State Date	Arvind Vardarajan SANTHANAM
Done at _____, on _____	_____
City, State Date	Brian Clarke BANISTER
Done at _____, on _____	_____
City, State Date	Raghu Narayan CHALLA
Done at _____, on _____	_____
City, State Date	Ruhua HE
Done at _____, on _____	_____
City, State Date	Daniel AMERGA
Done at _____, on _____	_____
City, State Date	Subashini KRISHNAMURTHY
Done at _____, on _____	_____
City, State Date	Scott HOOVER
Done at _____, on _____	_____
City, State Date	Sandeep RAO
Done at _____, on _____	_____
City, State Date	Zhang ZHOU

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____	_____
City, State	Date
_____	Kuo-Chun LEE
Done at _____, on _____	_____
City, State	Date
_____	Arvind Vardarajan SANTHANAM
Done at <u>San Diego, CA</u> , on <u>24-Mar-2021</u>	_____
City, State	Date
_____	Brian Clarke BANISTER
Done at _____, on _____	_____
City, State	Date
_____	Raghu Narayan CHALLA
Done at _____, on _____	_____
City, State	Date
_____	Ruhua HE
Done at _____, on _____	_____
City, State	Date
_____	Daniel AMERGA
Done at _____, on _____	_____
City, State	Date
_____	Subashini KRISHNAMURTHY
Done at _____, on _____	_____
City, State	Date
_____	Scott HOOVER
Done at _____, on _____	_____
City, State	Date
_____	Sandeep RAO
Done at _____, on _____	_____
City, State	Date
_____	Zhang ZHOU

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	Kuo-Chun LEE
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	Arvind Vardarajan SANTHANAM
Done at _____, on _____ City, State Date	_____
Done at San diego, CA, USA, on 3/25/2021 City, State Date	Brian Clarke BANISTER 
Done at _____, on _____ City, State Date	Raghu Narayan CHALLA
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	Ruhua HE
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	Daniel AMERGA
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	Subashini KRISHNAMURTHY
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	Scott HOOVER
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	Sandeep RAO
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	Zhang ZHOU

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Done at _____, on _____	_____
City, State	Date
_____	Kuo-Chun LEE
Done at _____, on _____	_____
City, State	Date
_____	Arvind Vardarajan SANTHANAM
Done at _____, on _____	_____
City, State	Date
_____	Brian Clarke BANISTER
Done at _____, on _____	_____
City, State	Date
_____	Raghu Narayan CHALLA
Done at <u>San Diego, CA</u> , on <u>3/25/2021</u>	<u>Ruhua HE</u>
City, State	Date
_____	Ruhua HE
Done at _____, on _____	_____
City, State	Date
_____	Daniel AMERGA
Done at _____, on _____	_____
City, State	Date
_____	Subashini KRISHNAMURTHY
Done at _____, on _____	_____
City, State	Date
_____	Scott HOOVER
Done at _____, on _____	_____
City, State	Date
_____	Sandeep RAO
Done at _____, on _____	_____
City, State	Date
_____	Zhang ZHOU

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Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	Kuo-Chun LEE
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	Arvind Vardarajan SANTHANAM
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	Brian Clarke BANISTER
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	Raghu Narayan CHALLA
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	Ruhua HE
Done at <u>SAN DIEGO, CA</u> , on <u>10/22/2020</u> City, State Date	 Daniel AMERGA
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	Subashini KRISHNAMURTHY
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	Scott HOOVER
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	Sandeep RAO
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	Zhang ZHOU

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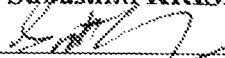
AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	_____
Done at <u>SAN DIEGO, CA</u> , on <u>3/29/2021</u> City, State Date	<u>Subashini K.</u> Subashini KRISHNAMURTHY
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	_____
Done at _____, on _____ City, State Date	_____

for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

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Done at _____, on _____	_____
City, State	Date
	Kuo-Chun LEE
Done at _____, on _____	_____
City, State	Date
	Arvind Vardarajan SANTHANAM
Done at _____, on _____	_____
City, State	Date
	Brian Clarke BANISTER
Done at _____, on _____	_____
City, State	Date
	Raghu Narayan CHALLA
Done at _____, on _____	_____
City, State	Date
	Ruhua HE
Done at _____, on _____	_____
City, State	Date
	Daniel AMERGA
Done at _____, on _____	_____
City, State	Date
	Subashini KRISHNAMURTHY
Done at <u>Del Mar, CA</u> , on <u>3/25/21</u>	
City, State	Date
	Scott HOOVER
Done at _____, on _____	_____
City, State	Date
	Sandeep RAO
Done at _____, on _____	_____
City, State	Date
	Zhang ZHOU

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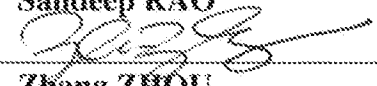
AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____	_____
City, State Date	Kuo-Chun LEE
Done at _____, on _____	_____
City, State Date	Arvind Vardarajan SANTHANAM
Done at _____, on _____	_____
City, State Date	Brian Clarke BANISTER
Done at _____, on _____	_____
City, State Date	Raghu Narayan CHALLA
Done at _____, on _____	_____
City, State Date	Ruhua HE
Done at _____, on _____	_____
City, State Date	Daniel AMERGA
Done at _____, on _____	_____
City, State Date	Subashini KRISHNAMURTHY
Done at _____, on _____	_____
City, State Date	Scott HOOVER
Done at SAN DIEGO, CA, on 02/28/2021	_____
City, State Date	Sandeep RAO
Done at _____, on _____	_____
City, State Date	Zhang ZHOU

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City, State Date	Arvind Vardarajan SANTHANAM
Done at _____, on _____	_____
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Done at _____, on _____	_____
City, State Date	Raghu Narayan CHALLA
Done at _____, on _____	_____
City, State Date	Ruhua HE
Done at _____, on _____	_____
City, State Date	Daniel AMERGA
Done at _____, on _____	_____
City, State Date	Subashini KRISHNAMURTHY
Done at _____, on _____	_____
City, State Date	Scott HOOVER
Done at _____, on _____	_____
City, State Date	Sandeep RAO
Done at <u>San Diego, California</u> , on <u>3/24/2021</u>	
City, State Date	Zhang ZHOU